Silicon NPN Power Transistors

2N6687

DESCRIPTION
·With TO-3 package
·Fast switching speed
·Low collector saturation voltage

APPLICATIONS
·For power supplies and other high-voltage switching applications

PINNING

PIN	DESCRIPTION
1	Base
2	Emitter
3	Collector
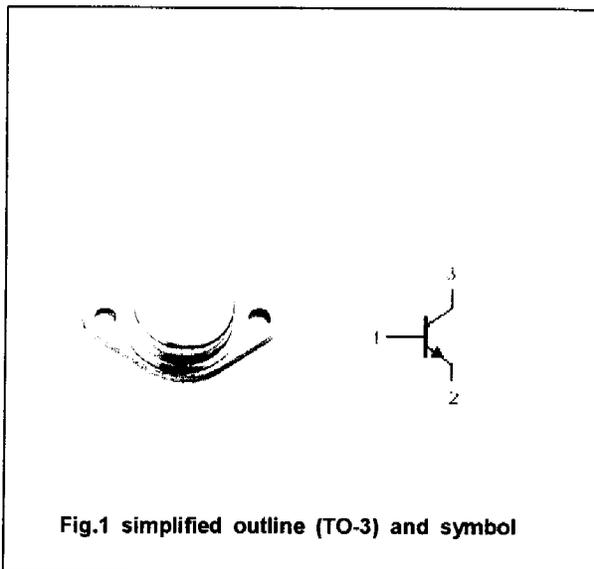
Fig.1 simplified outline (TO-3) and symbol

Absolute maximum ratings(Ta=□)

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V_{CBO}	Collector-base voltage	Open emitter	280	V
V_{CEO}	Collector-emitter voltage	Open base	180	V
V_{EBO}	Emitter-base voltage	Open collector	8	V
I_C	Collector current		25	A
I_{CM}	Collector current-peak		50	A
I_B	Base current		8	A
P_C	Collector power dissipation	T_C=25⌊	200	W
T_j	Junction temperature		200	⌊
T_{stg}	Storage temperature		-65~200	⌊

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
$R_{th j-c}$	Thermal resistance junction to case	0.875	⌊/W

Quality Semi-Conductors
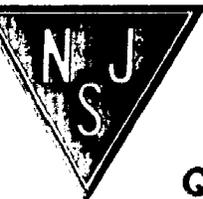
CHARACTERISTICS

Tj=25□ unless otherwise specified

| SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
$V_{CEO(SUS)}$	Collector-emitter sustaining voltage	I_C=0.2A ;I_B=0	180			V
V_{CEsat}	Collector-emitter saturation voltage	I_C=25A; I_B=2.5A			1.5	V
V_{BEsat}	Base-emitter saturation voltage	I_C=25A; I_B=2.5A			1.8	V
I_{CEV}	Collector cut-off current	V_{CE}=280V; V_{BE}=-1.5V			50	μA
I_{EBO}	Emitter cut-off current	V_{EB}=8V; I_C=0			100	μA
h_{FE-1}	DC current gain	I_C=1A ; V_{CE}=2V	30			
h_{FE-2}	DC current gain	I_C=10A ; V_{CE}=2V	25		100	
h_{FE-3}	DC current gain	I_C=25A ; V_{CE}=2V	15			
f_T	Transition frequency	I_C=1A ; V_{CE}=10V	20		100	MHz
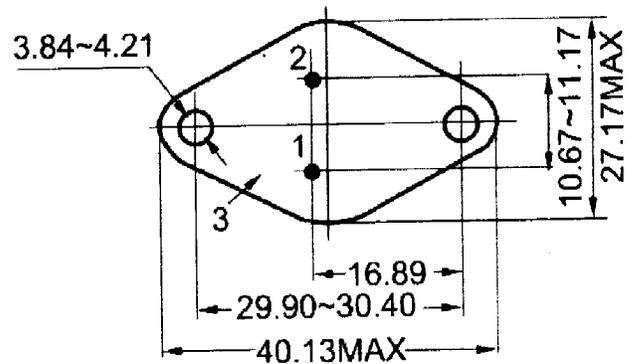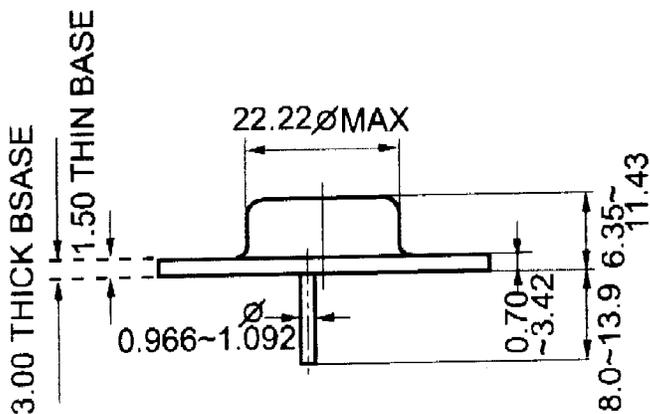
Fig.2 outline dimensions (unindicated tolerance:±0.1mm)